

Electronic Patent Application Fee Transmittal

Application Number:	10784888			
Filing Date:	24-Feb-2004			
Title of Invention:	Manufacturing method of semiconductor device with chamfering			
First Named Inventor/Applicant Name:	Akira Suzuki			
Filer:	Adam Chad Lilling/Wendy Rodriguez			
Attorney Docket Number:	606402016900			
Filed as Large Entity				
Utility Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Claims in excess of 20	1202	2	50	100
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				100